

06-08-2006

OMB No. 0651-0027 (exp. 6/30/2005)

Tab settings ⇌ ⇌ ⇌ ▼ ▼ ▼ ▼

103253754

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Yongzhong Hu and Sung-Shan Tai

2. Name and address of receiving party(ies)

Name: Alpha & Omega Semiconductor,
LTD.

Internal Address: _____

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:



Assignment



Merger



Security Agreement



Change of Name



Other _____

Street Address: 495 Mercury Drive

City: Sunnyvale State: CA Zip: 94085

Execution Date: May 30, 2006

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: May 30, 2006

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Bo-In Lin

Internal Address: _____

Street Address: 13445 Mandoli Drive

City: Los Altos Hills, State: CA Zip: 94022

6. Total number of applications and patents involved: ☒ 1

7. Total fee (37 CFR 3.41).....\$ 40.00



Enclosed



Authorized to be charged to deposit account

8. Deposit account number:

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Ching-lu Lin

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments, and documents: 3

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

PATENT

REEL: 017965 FRAME: 0906

ASSIGNMENT

INVENTOR Whereas, I, **YongZhong Hu** of 7584 Peach Blossom Drive
AND CITY Cupertino, California 95014

have invented:

TITLE: **FORMATION OF HIGH SHEET RESISTANCE RESISTORS AND HIGH
CAPACITANCE CAPACITORS BY A SINGLE POLYSILICON PROCESS**

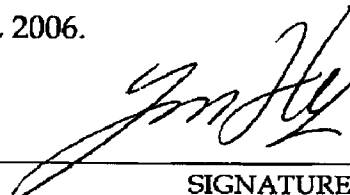
DATE INVENTOR and executed a United States patent application therefor
SIGNED THE
DECLARATION on May 25, 2006;

Whereas, **Alpha & Omega Semiconductor, LTD**, a Bermuda Company, having its registered address at Cannon's Court 22, Victoria Street, Hamilton HM12, Bermuda, (hereinafter called AOS), desires to acquire the entire right, title and interest of said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to AOS, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to AOS its successors and assigns; and I hereby agree that AOS may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by

CITY AND Signed and Sealed at Sunnyvale, California

DATE on May 25, 2006.



SIGNATURE OF INVENTOR

ASSIGNMENT

INVENTOR
AND CITYWhereas, I, **Sung-Shan Tai** of 1256 Lockhaven Way,
San Jose, California 95129

have invented:

TITLE:

**FORMATION OF HIGH SHEET RESISTANCE RESISTORS AND HIGH
CAPACITANCE CAPACITORS BY A SINGLE POLYSILICON PROCESS**DATE INVENTOR
SIGNED THE
DECLARATION

and executed a United States patent application therefor

on May 30th, 2006;

Whereas, **Alpha & Omega Semiconductor, LTD**, a Bermuda Company, having its registered address at Cannon's Court 22, Victoria Street, Hamilton HM12, Bermuda, (hereinafter called **AOS**), desires to acquire the entire right, title and interest of said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to **AOS**, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to **AOS** its successors and assigns; and I hereby agree that **AOS** may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by

CITY AND

Signed and Sealed at Sunnyvale, California

DATE

on May 30th, 2006.

SIGNATURE OF INVENTOR

PATENT